# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2711967

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
JI-YUN KWON	01/20/2014
JONG-HWA LEE	01/20/2014
HYUN-YONG CHO	01/20/2014
DAE-YUN KIM	01/20/2014
SANG-KYEON KIM	01/20/2014
SANG-KYUN KIM	01/20/2014
SANG-SOO KIM	01/20/2014
EUN-KYUNG YOON	01/20/2014
JUN-HO LEE	01/20/2014
JIN-YOUNG LEE	01/20/2014
HWAN-SUNG CHEON	01/20/2014
CHUNG-BEOM HONG	01/20/2014
EUN-HA HWANG	01/20/2014

# **RECEIVING PARTY DATA**

Name:	CHEIL INDUSTRIES INC.
Street Address:	58 GUMI-DAERO
Internal Address:	GUMI-SI, GYEONGSANGBUK-DO
City:	GUMI-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	730-710

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14236971

# **CORRESPONDENCE DATA**

**Fax Number**: (704)945-6735

PATENT 502665359 REEL: 032131 FRAME: 0461

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Correspondent Name: MELISSA B. PENDLETON

Address Line 1: 11610 N. COMMUNITY HOUSE ROAD

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Address Line 4: CHARLOTTE, NORTH CAROLINA 28277

ATTORNEY DOCKET NUMBER:	7020.169
NAME OF SUBMITTER:	MELISSA B. PENDLETON
Signature:	/Melissa B. Pendleton/
Date:	02/04/2014

Total Attachments: 6

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> PATENT REEL: 032131 FRAME: 0462

Form PTO-1595 (Rev. 08/05) OMB No. 0651-0027 (exp. 6/30/2008)

RECORDATION FORM COVER SHEET PATENTS ONLY			
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.			
1. Name of conveying party(ies) 1) JI-YUN KWON 2) JONG-HWA LEE 9) JUN-HO LEE 3) HYUN-YONG CHO 10) JIN-YOUNG LEE 4) DAE-YUN KIM 11) HWAN-SUNG CHEON 5) SANG-KYEON KIM 12) CHUNG-BEOM HONG 6) SANG-KYUN KIM 13) EUN-HA HWANG	2. Name and address of receiving party(ies) Name: Cheil Industries Inc. Internal Address:		
7) SANG-SOO KIM Additional name(s) of conveying party(ies) attached? Yes X No	EQ Cumi dooro		
3. Nature of conveyance/Execution Date(s):  Execution Date(s) January 20, 2014	Street Address: 58 Gumi-daero		
Assignment Merger  Security Agreement Change of Name	City: Gumi-si		
Joint Research Agreement	<sub>State:</sub> Gyeongsangbuk-do		
Government Interest Assignment Executive Order 9424, Confirmatory License	Country: South Korea Zip: 730-710		
Other	Additional name(s) & address(es) attached? Yes 🗶 No		
A. Patent Application No.(s) 14/236,971  Additional numbers att	document is being filed together with a new application.  B. Patent No.(s)  ached? Yes No		
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1		
Name: Additon, Higgins, Pendleton & Ashe, P.A.			
Internal Address:	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00 X Authorized to be charged by credit card		
memary duress.	Authorized to be charged by credit card  Authorized to be charged to deposit account		
Street Address: 11610 N. Community House	Enclosed		
Road, Suite 200	None required (government interest not affecting title)		
City: Charlotte	8. Payment Information		
State: NC Zip: 28277-2199	a. Credit Card Last 4 Numbers Expiration Date		
Phone Number: 704-945-6700	,		
Fax Number: 704-945-6735	b. Deposit Account Number		
Email Address:	Authorized User Name		
9. Signature: /Melissa B. Pendleton/	February 4, 2014		
Signature Melissa B. Pendleton	Date		
Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:		

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

#### ASSIGNMENT

WHEREAS, I, Ji-Yun KWON, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Jong-Hwa LEE, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Hyun-Yong CHO, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Dae-Yun KIM, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Sang-Kyeon KIM, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Sang-Kyun KIM, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Sang-Soo KIM, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Eun-Kyung YOON, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Jun-Ho LEE, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Jin-Young LEE, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Hwan-Sung CHEON, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Chung-Beom HONG, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; and Eun-Ha HWANG, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new

> PATENT REEL: 032131 FRAME: 0464

and useful improvements (hereinafter collectively referred to as "INVENTION") in *Positive Photosensitive Resin Composition*, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from an International Application filed on July 17, 2012, under Serial No. PCT/KR2012/005691 and a Korean application filed on December 30, 2011, under Serial No. 10-2011-0147877, all applications listed above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 58 Gumi-daero, Gumi-si, Gyeongsangbuk-do 730-710, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest—and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest—in and to said INVENTION and APPLICATION, in and to any and all continuations, continuations—in—part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION

in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

As the below named inventor, I hereby declare:

The application for United States Letters Patent being filed concurrently herewith was made or authorized to be made by me.

I believe that I am the original or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in the declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

	2014	Ji-Yun KWON
January 20	2014	Jong-Hwa LEE
January 20	2014	Hyun-Yong CHO
January 20	2014	Dae-Yun KIM
January 20	2014	フォル Sang-Kyeon KIM
January 20	2014	Sang-Kyun KIM
January 20	2014	71 Kb + Sang-Soo KIM
January 20	2014	Eun-Kyung YOON
January 20	2014	Jun-Ho LEE
January 20 ,	2014	Jin-Young LEE
January 20,	2014	Hwan-Sung CHEON

January 20 , 2014	Chung-Beom HONG
January 20 , 2014	ELD-HO HWANG